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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Chun Hsien Lin et al.	§	Docket No.:	2002.0992 / 24061.495
		§		
Serial No.:	10/723,236	§		
		§	Examiner:	Lee D. Wilson
Filed:	November 26, 2003	§		
		§	Art Unit:	2812
For:	An Advanced Process Control	§		
	Approach for CU Interconnect	§	Conf. No.:	9176
	Wiring Sheet Resistance	§		
	Control	§		

TRANSMITTAL

Mail Stop: Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified patent application.

1. Response to Office Action dated September 22, 2005;
2. Information Disclosure Statement Form 1449;
3. Check in the amount of \$180 (for IDS fee);
4. This transmittal, in duplicate; and
5. Return postcard.

The Director is authorized to charge any deficiency fees or credit any overpayments associated with this communication to Deposit Account No. 08-1394 of Haynes and Boone, LLP.

Respectfully submitted,

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Agent for Applicants
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Date: 12/21/05

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File: 2002.0992 / 24061.495

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on October 17, 2005.

December 21, 2005

Bonnie Boyle
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